

## AC/DC WLED Driver with External MOSFET Universal High Brightness

### DESCRIPTION

The TS19450 is an open loop, current mode control LED driver IC. It can be programmed to operate in either a constant frequency or constant off-time mode. It includes an 8V~450V linear regulator which allows it to work from a wide range of input voltages without the need for an external low voltage supply. The TS19450 includes a PWM dimming input that can accept an external control signal with a duty ratio of 0~100% and a frequency of up to a few kHz. It also includes a 0~250mV linear dimming input which can be used for linear dimming of the LED current.

The TS19450 is ideally suited for buck LED drivers. Since it operates in open loop current mode control, the controller achieves good output current regulation without the need for any loop compensation. PWM dimming response is limited only by the rate of rise and fall of the inductor current, enabling very fast rise and fall times. The TS19450 requires only free external components (apart from the power stage) to produce a controlled LED current making it an ideal solution for low cost LED drivers.

### FEATURES

- Switch mode controller for single switch LED drivers
- Open loop peak current controller
- Internal 8V~450V linear regulator
- Constant frequency or constant off-time operation
- Linear and PWM dimming capability
- Requires few external components for operation

### APPLICATION

- DC/DC or AC/DC LED driver applications
- RGB backlighting LED driver
- Back lighting of flat panel displays
- General purpose constant current source
- Signage and decorative LED lighting
- Charger

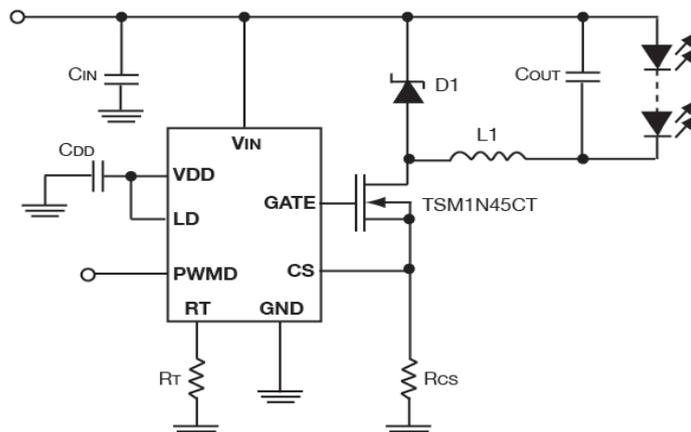


#### Pin Definition:

- |             |             |
|-------------|-------------|
| 1. $V_{IN}$ | 8. RT       |
| 2. CS       | 7. LD       |
| 3. GND      | 6. $V_{DD}$ |
| 4. Gate     | 5. PWMD     |

**Notes:** Moisture sensitivity level: level 3. Per J-STD-020

### TYPICAL APPLICATION CIRCUIT



<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise specified) <sup>(Note 1)</sup>			
PARAMETER	SYMBOL	LIMIT	UNIT
Input Voltage Range	$V_{IN}$ to GND	-0.5 ~ +470	V
Internal Regulated Voltage	$V_{DD}$ to GND	13.5	V
CS, LD, PWMD, Gate, RT to GND		-0.3 ~ ( $V_{DD}+0.3$ )	V
Continuous Power Dissipation <sup>(Note 2)</sup>	$P_D$	630	mW
Storage Temperature Range	$T_A$	-65 to +150	$^\circ\text{C}$
Junction Temperature Range	$T_J$	-40 to +150	$^\circ\text{C}$

<b>THERMAL PERFORMANCE</b> <sup>(Note 3)</sup>			
PARAMETER	SYMBOL	LIMIT	UNIT
Thermal Resistance – Junction to Ambient	$R_{\theta JA}$	128	$^\circ\text{C/W}$

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ , $V_{IN} = 12\text{V}$ , unless otherwise noted) <sup>(Note 4)</sup>						
PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
<b>Input</b>						
DC Input Voltage Range	$V_{INDC}$	DC input voltage	8.0	--	450	V
Shut-down Mode Supply Current	$I_{INSD}$	Pin PWMD to GND	--	0.5	1.0	mA
<b>Internal Regulator</b>						
Internally Regulated Voltage	$V_{DD}$	$V_{IN}=8\text{V}$ , $I_{DD(EXT)}=0$ , 500pF at Gate, $R_T=226\text{k}\Omega$	7.25	7.5	7.75	V
Line Regulation of $V_{DD}$	$\Delta V_{DDLine}$	$V_{IN}=8\sim 450\text{V}$ , $I_{DD(EXT)}=0$ 500pF at Gate, $R_T=226\text{k}\Omega$	0	--	1.0	V
Load Regulation of $V_{DD}$	$\Delta V_{DDLload}$	$I_{DD(EXT)}=0 \sim 1\text{mA}$ 500pF at Gate, $R_T=226\text{k}\Omega$ , PWMD= $V_{DD}$	0	--	100	mV
Undervoltage Lockout Threshold	UVLO	$V_{IN}$ rising	6.45	6.7	6.95	V
Undervoltage Lockout Hysteresis	$\Delta UVLO$	$V_{IN}$ falling	--	500	--	mV
VDD current available for external circuitry <sup>(Note 5)</sup>	$V_{DD(EXT)}$	$V_{IN}=8\text{V}\sim 100\text{V}$	--	--	1.0	mA
<b>Dimming</b>						
PWMD Input Low Voltage	$V_{ENL}$	$V_{IN}=8\text{V}\sim 450\text{V}$	--	--	1.0	V
PWMD Input High Voltage	$V_{ENH}$	$V_{IN}=8\text{V}\sim 450\text{V}$	2.4	--	--	V
PWMD Pull-down resistance at PWMD	$R_{EN}$	$V_{PWMD}=5\text{V}$	50	100	150	$\text{k}\Omega$
Linear Dimming pin Voltage	$V_{LD}$	$V_{IN}=12\text{V}$	0	--	250	mV

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A=25^{\circ}\text{C}$ , $V_{\text{IN}}=12\text{V}$ , unless otherwise noted) <sup>(Note 4)</sup>						
PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
<b>Current Sense Comparator</b>						
Current Sense Pull-in Threshold Voltage	$V_{\text{CSTH}}$	$-40^{\circ}\text{C} < T_A < +85^{\circ}\text{C}$	225	250	275	mV
		$T_A < +125^{\circ}\text{C}$	213	250	287	
Offset Voltage for LD Comparator	$V_{\text{OFFSET}}$		-12	--	12	mV
Current Sense Blanking Interval	$T_{\text{BLANK}}$	$V_{\text{LD}}=V_{\text{DD}}$ , $V_{\text{CS}}=0.55V_{\text{LD}}$	150	215	280	ns
Delay to Output	$T_{\text{DELAY}}$	$V_{\text{IN}}=12\text{V}$ , $V_{\text{LD}}=0.15\text{V}$ , $V_{\text{CS}}=0\sim 0.22\text{V}$ after $T_{\text{BLANK}}$	--	--	300	ns
<b>Oscillator</b>						
Oscillator Frequency	$f_{\text{OSC}}$	$R_T=1\text{M}\Omega$	20	25	30	kHz
		$R_T=223\text{k}\Omega$	80	100	120	
Max. Oscillator PWM Duty Cycle	$D_{\text{MAX}}$	$F=25\text{kHz}$ at Gate, CS to GND	--	--	100	%
<b>Gate Driver</b>						
Gate Sourcing Current	$I_{\text{SOURCE}}$	$V_{\text{GATE}}=0\text{V}$ , $V_{\text{DD}}=7.5\text{V}$	165	--	--	mA
Gate Sinking Current	$I_{\text{SINK}}$	$V_{\text{GATE}}=V_{\text{DD}}$ , $V_{\text{DD}}=7.5\text{V}$	165	--	--	mA
Gate High Output Voltage	$V_{\text{GATE(HI)}}$	$I_{\text{OUT}}=-10\text{mA}$	$V_{\text{DD}}-0.3$	--	$V_{\text{DD}}$	V
Gate Low Output Voltage	$V_{\text{GATE(LO)}}$	$I_{\text{OUT}}=10\text{mA}$	0	--	0.3	V
Gate Output Rise Time	$T_{\text{RISE}}$	$C_{\text{GATE}}=500\text{pF}$ , 10%~90% $V_{\text{GATE}}$	--	30	50	ns
Gate Output Fall Time	$T_{\text{FALL}}$	$C_{\text{GATE}}=500\text{pF}$ , 90%~10% $V_{\text{GATE}}$	--	30	50	ns

**Note:**

1. Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
2. Limited by package power dissipation, whichever is lower.
3. Thermal Resistance is specified with the component mounted on a low effective thermal conductivity test board in free air at  $T_A=25^{\circ}\text{C}$ .
4. Denotes the specifications which apply over the full operating ambient temperature range of  $-40^{\circ}\text{C}<T_A<+125^{\circ}\text{C}$ .
5.  $V_{\text{DD}}$  load current external to the TS19450.

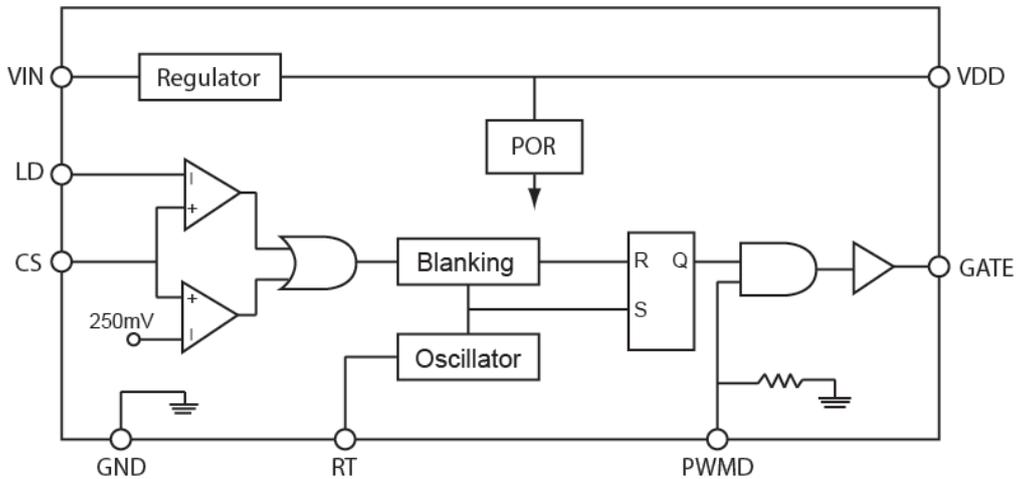
**ORDERING INFORMATION**

<b>PART NO.</b>	<b>PACKAGE</b>	<b>PACKING</b>
TS19450CS RLG	SOP-8	2,500pcs / 13" Reel

**Note:**

1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC.
2. Halogen-free according to IEC 61249-2-21 definition.

**FUNCTION BLOCK DIAGRAM**



**PIN DESCRIPTION**

PIN NO.	NAME	FUNCTION
1	VIN	This pin is the input of 8V~450V linear regulator
2	CS	This pin is the current sense pin used to sense the MOSFET current by means of an external sense resistor. When this pin exceeds the low of either the internal 250mV or the voltage at the LD pin, the GATE output goes low
3	GND	Ground return for all internal circuitry. This pin must be electrically connected to the ground of the power train.
4	GATE	This pin is the output GATE driver for an external N-CH Power MOSFET
5	PWMD	This is the PWM dimming input of the IC. When this pin is pulled to GND, the Gate Driver is turned off. When the pin is pulled high, the GATE driver operates normally.
6	VDD	This is the power supply pin for all internal circuits. It must be bypassed with a low ESR capacitor to GND ( $\geq 0.1\mu\text{F}$ )
7	LD	This pin is the linear dimming input and sets the current sense threshold as long as the voltage at the pin is less than 250mV (typ.)
8	RT	This pin sets the oscillator frequency. When a resistor is connected between RT and GND, the IC operates in constant frequency mode. When the resistor is connected between RT and GATE, the IC operates in constant off-time mode.

## APPLICATION INFORMATION

The TS19450 is optimized to drive buck LED drivers using open-loop peak current mode control. This method of control enables fairly accurate LED current control without the need for high side current sensing or the design of any closed loop controllers. The IC uses very few external components and enables both linear and PWM dimming of the LED current.

A resistor connected to the RT pin programs the frequency of operation (or the off-time). The oscillator produces pulses at regular intervals. These pulses set the SR flip-flop in the TS19450 which causes the GATE driver to turn on. The same pulses also start the blanking timer which inhibits the reset input of the SR flip flop and prevent false turn-offs due to the turn-on spike. When the FET turns on, the current through the inductor starts ramping up. This current flows through the external sense resistor  $R_{CS}$  and produces a ramp voltage at the CS pin. The comparators are constantly comparing the CS pin voltage to both the voltage at the LD pin and the internal 250mV. Once the blanking timer is complete, the output of these comparators is allowed to reset the flip flop. When the output of either one of the two comparators goes high, the flip flop is reset and the GATE output goes low. The GATE goes low until the SR flip flop is set by the oscillator. Assuming a 30% ripple in the inductor, the current sense resistor  $R_{CS}$  can be set using:

$$R_{CS} = \frac{0.25V(\text{or } V_{LD})}{1.15 \times I_{LED} (A)}$$

Constant frequency peak current mode control has an inherent disadvantage – at duty cycles greater than 0.5, the control scheme goes into sub harmonic oscillations. To prevent this, an artificial slope is typically added to the current sense waveform. This slope compensation scheme will affect the accuracy of the LED current in the present form. However, a constant off-time peak current control scheme does not have this problem and can easily operate at duty cycles greater than 0.5 and also gives inherent input voltage rejection making the LED current almost insensitive to input voltage variations. But, it leads to variable frequency operation and the frequency range depends greatly on the input and output voltage variation. TS19450 makes it easy to switch between the two modes of operation by changing one connection (see oscillator section).

### Input Voltage Regulator

The TS19450 can be powered directly from its VIN pin and can work from 8.0V~450VDC at its VIN pin. When a voltage is applied at the VIN pin, the TS19450 maintains a constant 7.5V at the VDD pin. This voltage is used to power the IC and any external resistor dividers needed to control the IC. The VDD pin must be bypassed by a low ESR capacitor to provide a low impedance path for the high frequency current of the output GATE driver.

The TS19450 can be also operated by supplying a voltage at the VDD pin greater than the internally regulated voltage. This will turn off the internal linear regulator of the IC and the TS19450 will operate directly off the voltage supplied at the VDD pin. Please note that this external voltage at the VDD pin should not exceed 12V.

Although the VIN pin of the TS19450 is rated up to 450V, the actual maximum voltage that can be applied is limited by the power dissipation in the IC. For example, if an SOP-8 (junction to ambient thermal resistance  $R_{\theta JA} = 128^{\circ}\text{C}/\text{W}$ ) TS19450 draws about  $I_{IN} = 2.0\text{mA}$  from the VIN pin, and has a maximum allowable temperature rise of the junction temperature limited to about  $\Delta T = 10^{\circ}\text{C}$  the maximum voltage at the VIN pin would be:

$$V_{IN(\text{MAX})} = \frac{\Delta T}{R_{\theta JA}} \times \frac{1}{I_{IN}} = \frac{100^{\circ}\text{C}}{128^{\circ}\text{C}/\text{W}} \times \frac{1}{2\text{mA}} = 390\text{V}$$

In these cases, to operate the TS19450 from higher input voltages, a Zener diode can be added in series with the VIN pin to divert some of the power loss from the TS19450 to the Zener diode. In the above example, using a 100V Zener diode will allow the circuit to easily work up to 450V.

## **APPLICATION INFORMATION (CONTINUE)**

The input current drawn from the VIN pin is a sum of the 1.0mA current drawn by the internal circuit and the current drawn by the GATE driver (which in turn depends on the switching frequency and the GATE charge of the external

$$I_{IN} \approx 1\text{mA} + Q_G \times f_S$$

In the above equation,  $f_S$  is the switching frequency and  $Q_G$  is the GATE charge of the external MOSFET (which can be obtained from the datasheet of the MOSFET).

### **Current Sense**

The current sense input of the TS19450 goes to the non-inverting inputs of two comparators. The inverting terminal of one comparator is tied to an internal 250mV reference whereas the inverting terminal of the other comparator is connected to the LD pin. The outputs of both these comparators are fed into an OR GATE and the output of the OR GATE is fed into the reset pin of the flip-flop. Thus, the comparator which has the lowest voltage at the inverting terminal determines when the GATE output is turned off.

The outputs of the comparators also include a 150~280ns blanking time which prevents spurious turn-offs of the external MOSFET due to the turn-on spike normally present in peak current mode control. In rare cases, this internal blanking might not be enough to filter out the turn-on spike. In these cases, an external RC filter needs to be added between the external sense resistor ( $R_{CS}$ ) and the CS pin.

Please note that the comparators are fast (with a typical 80ns response time). Hence these comparators are more susceptible to be triggered by noise than the comparators of the TS19450. A proper layout minimizing external inductances will prevent false triggering of these comparators.

### **Oscillator**

The oscillator in the TS19450 is controlled by a single resistor connected at the RT pin. The equation governing the oscillator time period  $t_{OSC}$  is given by:

$$t_{osc} = \frac{RT(k\Omega)+22}{25}$$

If the resistor is connected between RT and GND, TS19450 operates in a constant frequency mode and the above equation determines the time-period. If the resistor is connected between RT and GATE, the TS19450 operates in a constant off-time mode and the above equation determines the off-time.

### **PWM Dimming**

PWM Dimming can be achieved by driving the PWMD pin with a low frequency square wave signal. When the PWM signal is zero, the GATE driver is turned off and when the PWMD signal is high, the GATE driver is enabled. Since the PWMD signal does not turn off the other parts of the IC, the response of the TS19450 to the PWMD signal is almost instantaneous. The rate of rise and fall of the LED current is thus determined solely by the rise and fall times of the inductor current.

To disable PWM dimming and enable the TS19450 permanently, connect the PWMD pin to VDD.

## APPLICATION INFORMATION (CONTINUE)

### Linear Dimming

The Linear Dimming pin is used to control the LED current. There are two cases when it may be necessary to use the Linear Dimming pin.

\* In some cases, it may not be possible to find the exact value required to obtain the LED current when the  $R_{CS}$  internal 250mV is used. In these cases, an external voltage divider from the VDD pin can be connected to the LD pin to obtain a voltage (less than 250mV) corresponding to the desired voltage across  $R_{CS}$ .

\* Linear dimming may be desired to adjust the current level to reduce the intensity of the LEDs. In these cases, an external 0~250mV voltage can be connected to the LD pin to adjust the LED current during operation.

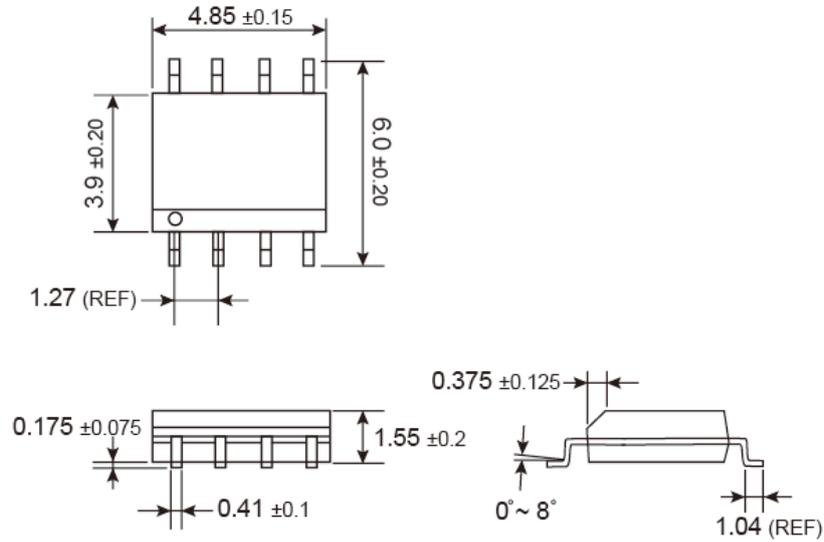
To use the internal 250mV, the LD pin can be connected to VDD.

### **Note:**

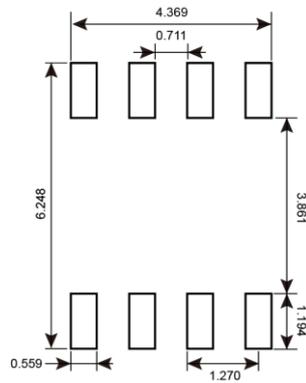
Although the LD pin can be pulled to GND, the output current will not go to zero. This is due to the presence of a minimum on-time (which is equal to the sum of the blanking time and the delay to output time) which is about 450ns. This will cause the MOSFET to be on for a minimum of 450ns and thus the LED current when LD = GND will not be zero. This current is also dependent on the input voltage, inductance value, forward voltage of the LEDs and circuit parasitic. To get zero LED current, the PWMD pin has to be used.

**PACKAGE OUTLINE DIMENSIONS** (Unit: Millimeters)

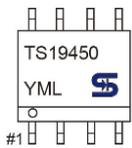
**SOP-8**



**SUGGESTED PAD LAYOUT** (Unit: Millimeters)



**Marking Diagram**



- Y** = Year Code
- M** = Month Code for Halogen Free Product
  - O** =Jan    **P** =Feb    **Q** =Mar    **R** =Apr
  - S** =May    **T** =Jun    **U** =Jul    **V** =Aug
  - W** =Sep    **X** =Oct    **Y** =Nov    **Z** =Dec
- L** = Lot Code (1~9, A~Z)

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